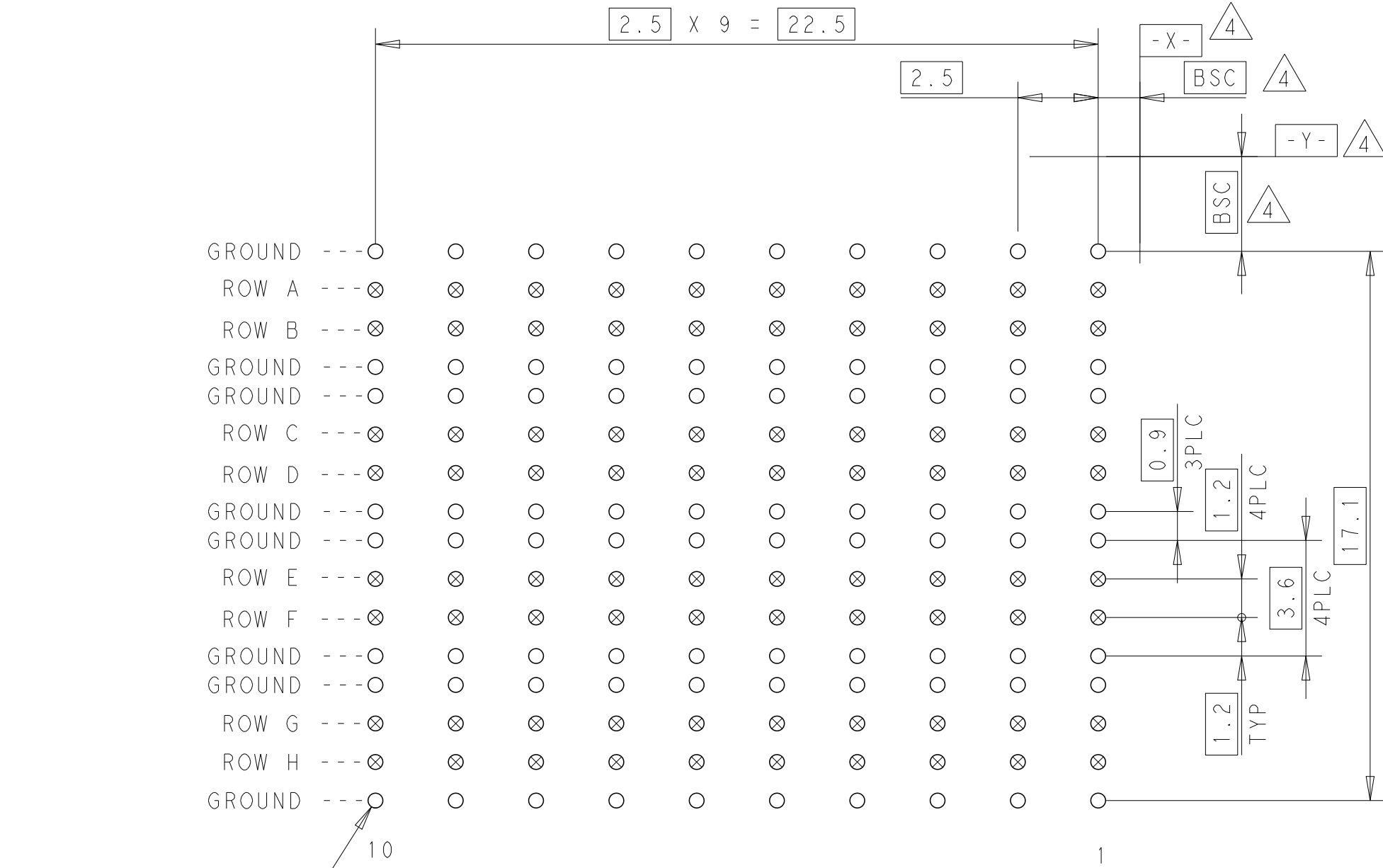
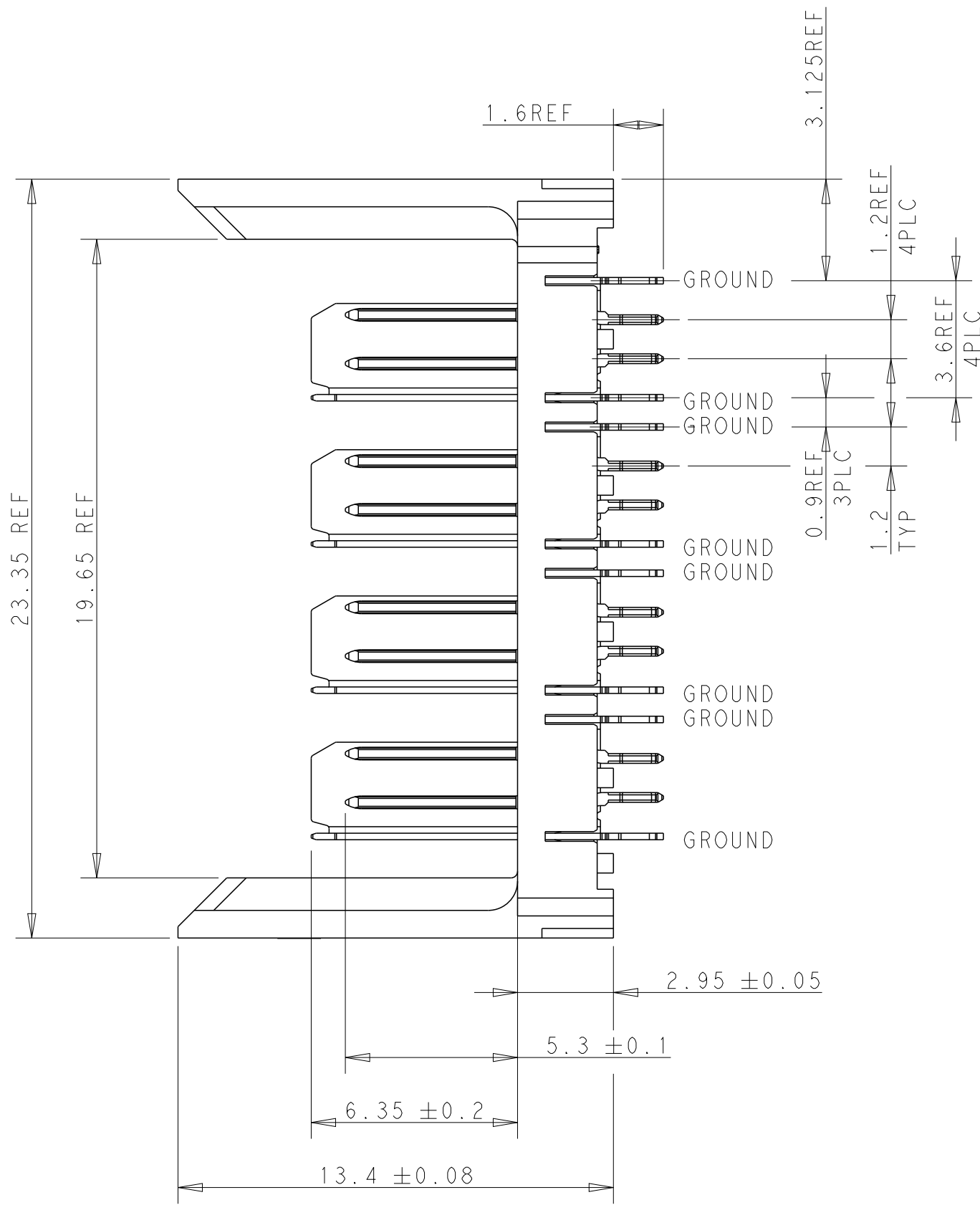
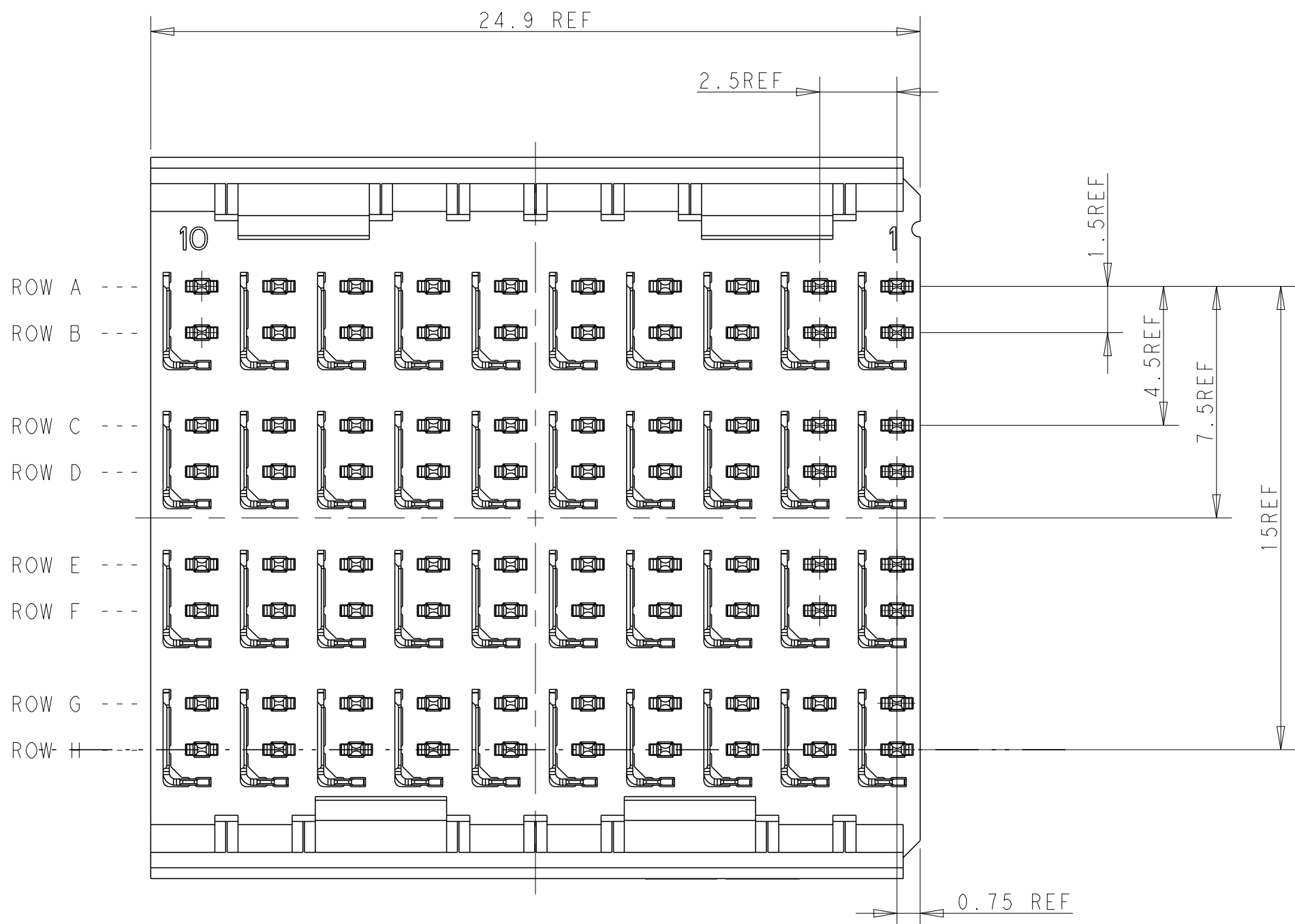


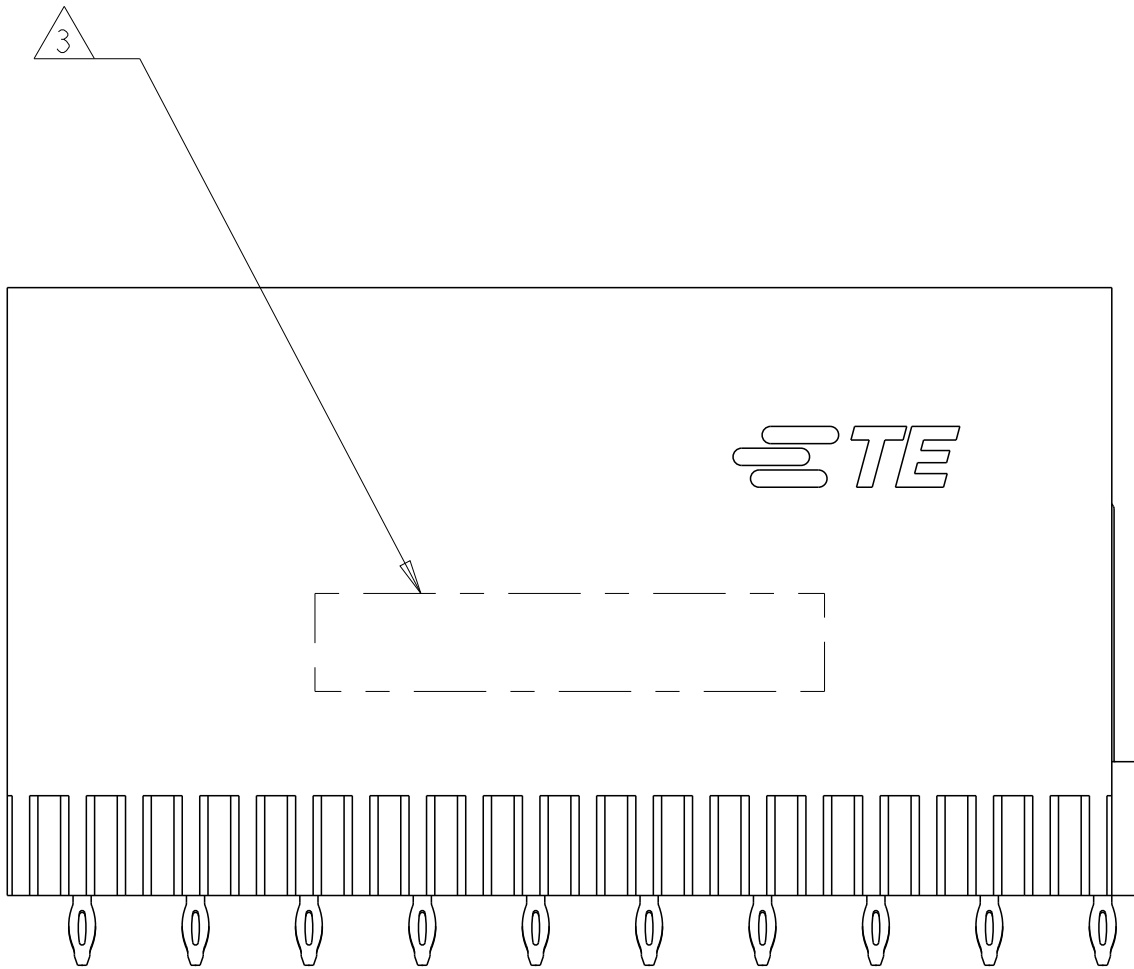
LOC		DIST		REVISIONS			
P	LTR	DESCRIPTION		DATE	DWN	APVD	
A		INITIAL RELEASE		7JAN2013	D.S	A.C	
B		PER ECR-13-008109		21MAY2013	D.S	M.Y	
C		PER ECR-15-012191		21AUG2015	D.S	F.Y	



6 Ø0.46 REF
Ø0.05 X Y
ALL PLATED HOLES.

RECOMMENDED PCB LAYOUT
VIEW FROM COMPONENT SIDE
SCALE 6:1

- 1 MATERIAL:
CONTACT AND SHIELD: PHOSPHOR BRONZE
HOUSING: THERMALPLASTIC,UL 94V-0
- 2 FINISH: SIGNAL AND GROUND CONTACTS:
MATING AREA: MEETS THE PERFORMANCE REQUIREMENTS OF
PRODUCT SPECIFICATION 108-2055-1; BASED ON TELCORDIA
GR-1217-CORE, APPLICATIONS IN UNCONTROLLED ENVIRONMENTS
COMPLIANT PIN AREA: 0.5 um MIN MATTE
TIN OVER BASE PLATING
- 3 CONNECTOR MARKED WITH PART NUMBER AND DATE CODE
- 4 DATUMS AND BASIC DIMENSIONS ESTABLISHED BY CUSTOMER
- 5 FINISH: SIGNAL AND GROUND CONTACTS:
0.76um MIN. GOLD PLATING
COMPLIANT PIN AREA: 0.5 um MIN MATTE TIN OVER BASE PLATING
- 6 CONTACT AREA LUBRICATED WITH BELLCORE
APPROVED LUBRICANT. TECHNICAL REFERENCE:
GR-1217-CORE, ISSUE 1, NOVEMBER 1995.
- 7 RECOMMENDED THRU HOLE DIAMETER AND PLATING THICKNESSES PLEASE
REFER TO APPLICATION SPEC 114-13059



5	2170330-2
2	2170330-1
FINISH	PART NO.

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CHK SANDERS YAN 23APR2012		APVD ALEX CAI 23APR2012		
DIMENSIONS: mm		PRODUCT SPEC 108-2055-1	NAME ASSEMBLY DRAWING 4 PAIR,10 COLUMN,VERTICAL HM ZD+,HEADER	
TOLERANCES UNLESS OTHERWISE SPECIFIED: 9-PLC ±0.20 7-PLC ±0.20 5-PLC ±0.20 4-PLC ±0.20 ANGLES ±0.20		APPLICATION SPEC 114-13059		
MATERIAL 1		WEIGHT -	SIZE A1	RESTRICTED TO -
FINISH 2		CUSTOMER DRAWING	SCALE 8:1	SHEET 1 OF 1
			REV C	